# WJA1515 5V Active-Bias InGaP HBT Gain Block

### **Product Features**

- 50 1000 MHz
- 15 dB Gain
- +19 dBm P1dB
- +38 dBm OIP3
- +5V Single Voltage Supply
- Internal Active Bias Supply
- Internally matched to  $50 \Omega$
- Lead-free / RoHS-compliant / Green SOT-89 package

# Applications

- IF Amplifier
- Repeaters, BTS Transceivers
- VHF/UHF
- Wireless Infrastructure
- General Purpose

### **Target Specifications**

Parameter	Units	Min	AR	Nax
Operational Bandwidth	MHz	50 <		1000
Test Frequency	MHz		200	$\sim$
Gain	dB	$\left( \Omega \right)$	14,7	
Input Return Loss	dB		J <sub>13</sub>	
Output Return Loss	dB 🗸	$\langle \rangle$	17	
Output P1dB	dBm	$\sim$	+19	
Output IP3 <sup>(2)</sup>	dBm	$\sim$	+37.8	
Noise Figure	d dB	$\sim$	4.6	
Device Voltage	V	2	5	
Device Current	mA		65	

Test conditions: 25 °C, Sheply Voltage = +5.V, 50  $\Omega$  System. 30IP measured with two tones at an output power of 0 dBm/tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the 30IP using a 2:1 rule.

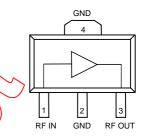
### **Product Description**

The WJA1515 is a high performance amplifier that offers high linearity in a low-cost surface-mount package. At 200 MHz, the WJA1515 typically provides 15 dB gain, +38 dBm OIP3, and +19 dBm P1dB. The device is housed that lead-free/green/RoHS-compliant SOT-89 industry-standard SMT package using a NiPdAu plating to eliminate the possibility of tin whiskering.

The WJA1515 consists of Darlington pair amplifiers using a high reliability InGaP/GaAs HBT process (echpology The MMIC amplifier is internally matched to  $50\Omega$  and only requires DC-blocking capacitors and an inductive RF ehoke for operation. Biased directly from a 5V supply, an internal active bias network enables stable operation over temperature, eliminating the need for the typical dropping bias resistor.

The amplifier is targeted for high performance IF applications in existing and next generation wireless technologies. In addition, the WJA1515 will work for various other applications within the 50 to 1000 MHz frequency range

### **Functional Diagram**



Function	Pin No.
Input	1
Output/Bias	3
Ground	2, 4

#### Target Performance

Parameter	Units	Typical			
Frequency	MHz	50	100	200	500
S21	dB	15.4	14.9	14.7	14.4
S11	dB	-12	-13	-13	-12
S22	dB	-14	-16	-17	-14
Output P1dB	dBm	+19	+19	+19	+19
Output IP3 <sup>(2)</sup>	dBm	+39	+39	+37.8	+37.8
Noise Figure	dB	4.5	4.5	4.6	4.6

### Absolute Maximum Rating

Parameter	Rating	Part	No.	Description
Operating Case Temperature	-40 to +85 °C	WJA1	515	+5V Active Bias InGaP HBT Gain Block (lead-free/green/RoHS-compliant SOT-89 Package)
Storage Temperature	-55 to +150 °C	WJA1	515-PCB	50 – 1000 MHz Fully Assembled Eval. Board

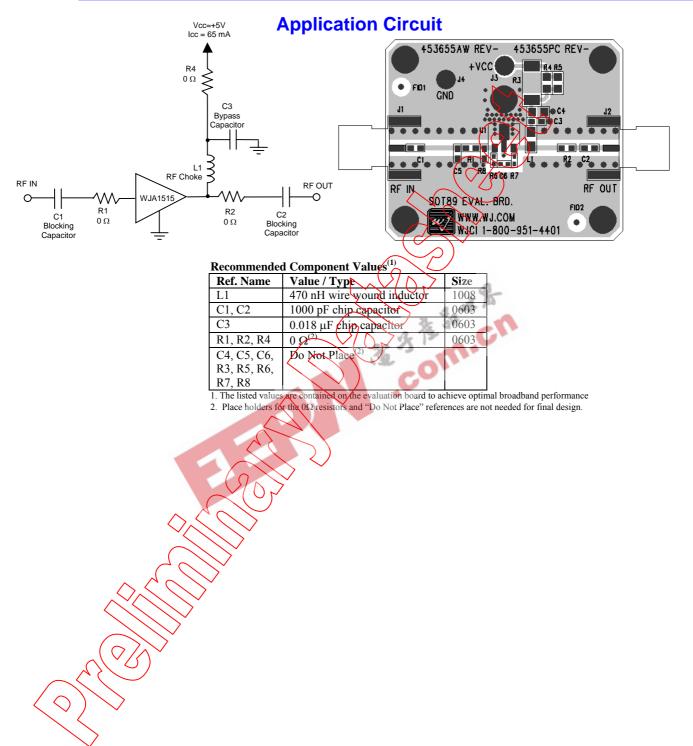
Operation of this device above any of these parameters may cause permanent damage

Part No.	Description
WJA1515	+5V Active Bias InGaP HBT Gain Block
WJA1515-PCB	(lead-free/green/RoHS-compliant SOT-89 Package) 50 – 1000 MHz Fully Assembled Eval. Board

**Ordering Information** 

Specifications and information are subject to change without notice







A1515 XXXX-X

14

.58 (.023)

H

← 2×81 ∲ 0.10 (0.004) Ø T Z S Y C

#### **Mechanical Information**

This package is lead-free/Green/RoHS-compliant. It is compatible with both lead-free (maximum 260 °C reflow temperature) and leaded (maximum 245 °C reflow temperature) soldering processes. The plating material on the leads is NiPdAu.

# **Outline Drawing**

Altern (May be

.016 .01

.35 (.014) 4.40 4.50 (.017) 4.60 (.181) 1.83

(.17)

Land Pattern

Ø.254 (.010) PLATED THRU GROUND VIAS

# **Broduct Marking**

The WIA1515 will be marked with an "A1515" designator with an alphanumeric lot code marked below the part designator.

Pape and reel specifications for this part are located on the website in the "Application Notes" section.

### **MSL / ESD Rating**

Caution! ESD sensitive device.

ESD Rating: Class 1C Value: Test: Standard:

Test:

.76 (.030) --.38 (.01

0 0 ф

С

2 11 ( 083)

76 (.030) TYP

2.54

Passes  $\geq 1000V$  min. Human Body Model (HBM) JEDEC Standard JESD22-A114

ESD Rating: Class IV Passes  $\geq 1000$ V min. Value: Charged Device Model (CDM) Standard: JEDEC Standard JESD22-C101

### **Mounting Config. Notes**

- 1. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- 2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- 3. Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
- 4. Do not put solder mask on the backside of the PC board in the region where the board contacts the heatsink.
- 5. RF trace width depends upon the PC board material and construction.
- 6. Use 1 oz. Copper minimum.
- 7. All dimensions are in millimeters (inches). Angles are in degrees.